Confirmation of environmental compatibility for supplied products

With the authentic signing of this document, we confirm that the CC2400, including the RSP package, does not contain or contain only a maximum concentration of 0.1% by weight in homogeneous materials for the following substances:

**Lead and lead compounds,**
**Mercury and mercury compounds,**
**Hexavalent chromium,**
**Polybrominated biphenyls (PBB),**
**Polybrominated biphenyl ethers (PBDE)**

and a maximum concentration of 0.01% by weight in homogeneous materials for

**Cadmium and cadmium compounds,**


Confirmation:

02/12/2005
(Date)

Viggo Grønløi, Product Manager
(Name, Function)
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